## **Schottky Diode Module**

Reverse Voltage 200V Forward Current 200 Amp

#### **Features**

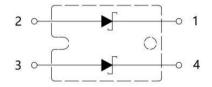
- Low Forward Voltage
- High Surge Current Capability
- Low Inductance Package

#### **Applications**

- Inversion Welder
- · Gemeral Power Supply
- Plating Power Supply
- Ultrasonic Cleaner and Welder
- Converter & Chopper



# Circuit



### Maximum Ratings

Symbol	Item	Conditions	Values	Unit
V <sub>R</sub>	Maximum D.C. Reverse Voltage		000	V
VRRM	Maximum Repetitive Reverse Voltage		200	
lfav	Average Forward Current	Rectangular , d=0.5 , Tc=102 $^{\circ}\!$	100	A
		Rectangular ,d=0.5 ,Tc=102℃, Per Moudle	200	
IFSM	Non-Repetitive Peak Surge Current	$T_j = 25^{\circ}C$ , $t = 50$ Hz(10ms), $V_R = 0V$ , Per Leg	1650	А
l²t	Circuit Fusing Consideration	t = 10ms T <sub>j</sub> =25°C	13600	A <sup>2</sup> s
Viso	Isolation Breakdown Voltage	AC 50Hz/60Hz; R.M.S; 1min	2500	V
Tj	Operating Junction Temperature		-40 to +150	°C
Tstg	Storage Temperature		-40 to +125	°C
Mt	Mauratia a Tanana	To Terminals(M4)	0.7~1.1	l
Ms	Mounting Torque	To Heatsink(M4)	0.7~1.1	N·m
Weight	Module (Approximately)		34	g

#### Thermal Characteristics

Symbol	Item	Conditions	Values	Unit
R <sub>th(j-c)</sub>	Thermal Impedance, Max	Junction to Case(Per Leg)	0.4	°C/W
R <sub>th(c-s)</sub>	Thermal Impedance, Max	Case to Heat Sink	0.1	°C/W

#### ■ Electrical Characteristics

Symbol	Item	Conditions	Values			Unit
			Min.	Тур.	Max.	Unit
V <sub>FM</sub>	Forward Voltage Drop Per Leg, Max	Tj=25℃ , I <sub>F</sub> =100A	_	_	1.0	V
IRRM	Repetitive Peak Reverse Current Per	$T_j = 25^{\circ}C$ $V_R = V_{RRM}$	_	_	0.2	mA
	Leg, Max	$T_j = 150$ °C $V_R = V_{RRM}$	_	_	20	
V <sub>T0</sub>	Threshold Voltage, for power loss calculation only	T <sub>j</sub> = 125°C	0.5		V	
ľτ	Slope Resistance, for power loss calculation only	T <sub>j</sub> = 125°C	3.5		mΩ	

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#### **Performance Curves**

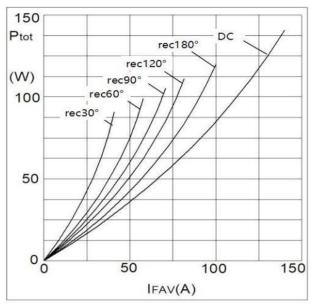


Fig1. Power Dissipation

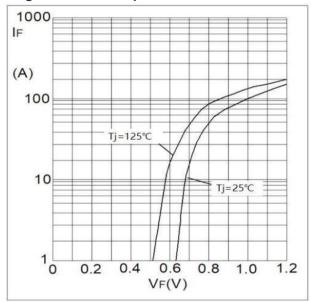


Fig3. Forward Characteristics

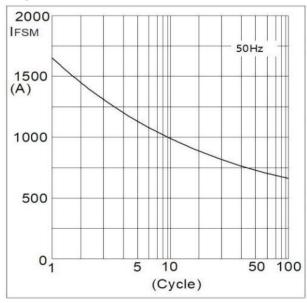


Fig5. Max Non-Repetitive Forward Surge Current

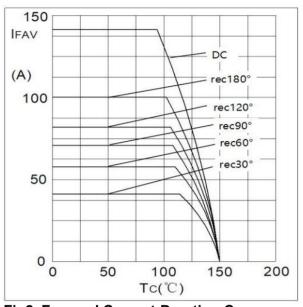


Fig2. Forward Current Derating Curve

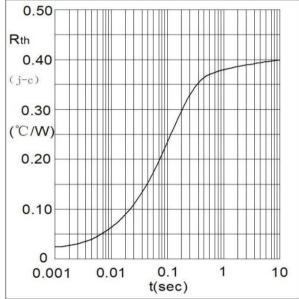


Fig4. Transient Thermal Impedance

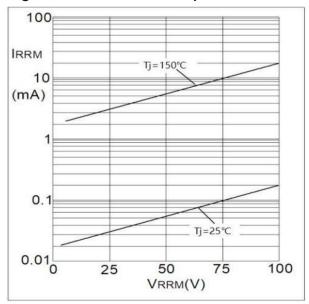
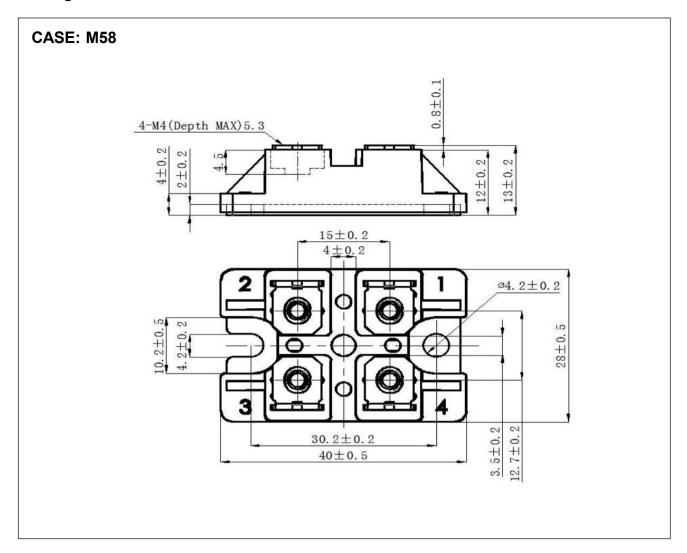


Fig6. Reverse Current VS Reverse Voltage

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#### Package Outline Information



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